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[**A Chip That Can Transfer Data Using Laser Light**](#)

By JOHN MARKOFF

Researchers say they have created a silicon-based chip that can produce laser beams to send data between chips by finding a way to glue a layer of indium phosphide to a silicon wafer

<http://www.nytimes.com/2006/09/18/technology/18chip.html?ex=1159243200&en=8341f6974de1581b&ei=5070&emc=eta1>

Intel Claims a Breakthrough

In Creating Lasers on Chips

Move to Silicon Platform

May Slash Network Costs;

More-Agile Photonics Gear

By DON CLARK

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<http://online.wsj.com/article/SB115854395109565949->

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